

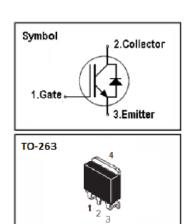
IGBT

Features

- 650V,25A
- $V_{CE(sat)(typ.)}$ =2.1V@ V_{GE} =15V, I_{C} =25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

General Description

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as Motor control, general inverter and other soft switching applications.



Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
Vces	Collector-Emitter Voltage	650	V	
V _{GES}	Gate-Emitter Voltage	<u>+</u> 30	V	
	Continuous Collector Current (Tc=25 °C)	50	А	
lc lc	Continuous Collector Current (Tc=100°C)	25	А	
Ісм	I _{CM} Pulsed Collector Current (Note 1)		А	
I _F	Diode Continuous Forward Current (T _C =100 °C)	25	А	
I _{FM}	Diode Maximum Forward Current (Note 1)	75	А	
t _{sc}	Short Circuit Withstand Time	10	us	
Б	Maximum Power Dissipation ($T_C=25 ^{\circ}\text{C}$)	138.9	W	
P _D	Maximum Power Dissipation (T _C =100°C)	55.6	W	
TJ	Operating Junction Temperature Range	-55 to +150	$^{\circ}$	
Tstg	Storage Temperature Range	-55 to +150	${\mathbb C}$	

Thermal Characteristics

Symbol	Parameter	Max.	Units
R _{th j-c}	Thermal Resistance, Junction to case for IGBT	0.9	°C/ W
R _{th j-c}	Thermal Resistance, Junction to case for Diode	1.2	°C/W
R _{th j-a}	Thermal Resistance, Junction to Ambient	65	°C/W



Electrical Characteristics (Tc=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	650	-	-	V
I _{CES}	Collector-Emitter Leakage Current	$V_{CE} = 650 V, V_{GE} = 0 V$	-	-	100	uA
I _{GES}	Gate Leakage Current, Forward	V_{GE} = ± 20 V, V_{CE} = 0 V	-	-	±100	nA
V _{GE(th)}	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 250uA$	5.1	-	6.9	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} =15V, I _C = 25A	-	2.1	2.7	V
Qg	Total Gate Charge	Vcc=480V	-	31.2		nC
Qge	Gate-Emitter Charge	V _{GE} =15V	-	7.7		nC
Qgc	Gate-Collector Charge	Ic=25A	-	13.3		nC
t _{d(on)}	Turn-on Delay Time		-	22	-	ns
t r	Turn-on Rise Time	V _{cc} =400V	-	44	-	ns
t d(off)	Turn-off Delay Time	V _{GE} =15V	-	75	-	ns
t f	Turn-off Fall Time	1l _C =25A R _G =15Ω	-	88	-	ns
Eon	Turn-on Switching Loss	Inductive Load	-	0.66	-	mJ
Eoff	Turn-off Switching Loss	T _C =25 ℃	-	0.49	-	mJ
Ets	Total Switching Loss		-	1.15	-	mJ
C _{ies}	Input Capacitance	V _{CE} =25V	-	978	-	pF
Coes	Output Capacitance	V _{GE} =0V	-	90	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	8	-	pF

$\underline{\textbf{Electrical Characteristics of Diode}}_{(T_C=25\,{}^{\circ}\!\text{C unless otherwise noted })}$

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _F	Diode Forward Voltage	I _F =25A	-	1.65	3.0	V
trr	Diode Reverse Recovery Time	V _{CE} = 400V	-	60		ns
Irr	Diode peak Reverse Recovery Current	I _F = 25A	-	15.6		Α
Qrr	Diode Reverse Recovery Charge	Rg=15 Ω	-	518		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics

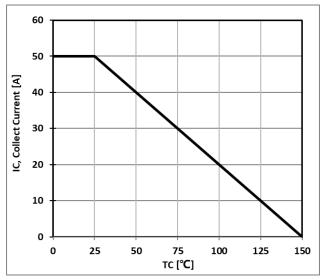


Figure 1: Maximum DC Collector Current VS. case temprature

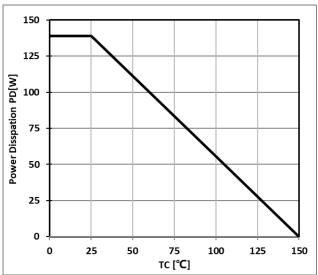


Figure 2: Power Dissipation VS. Case Temperature

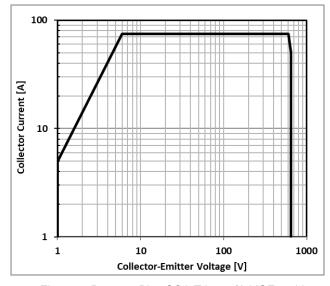


Figure 3: Reverse Bias SOA,TJ=125℃,VGE=15V

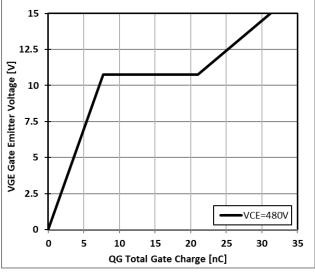
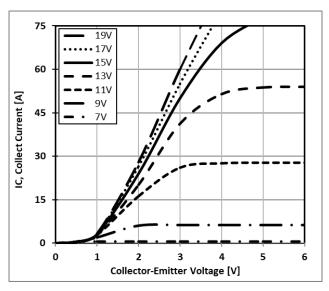


Figure 4: Typical Gate charge VS. VGE,IC=25A





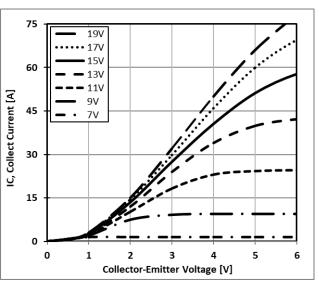


Figure 6: Typical IGBT Output characteristics, TC=150°C;tp=300us

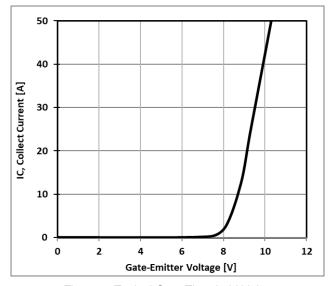


Figure 7: Typical Gate Threshold Voltage

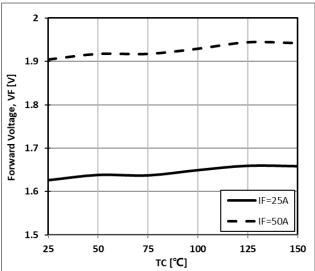


Figure 8: Typical Forward Voltage vs IF



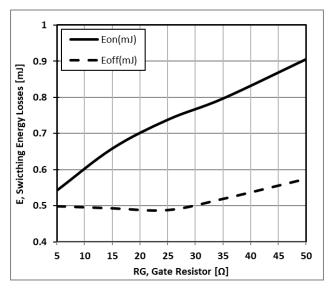


Figure 9: Typical Energy Loss VS. RG, TC=25°C, L=200uH,VCE=400V,VGE=15V,IC=25A

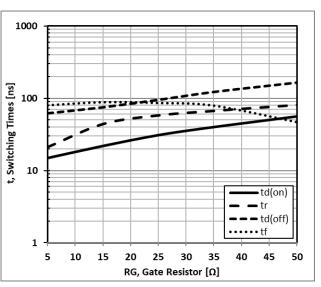


Figure 10: Typical Switching Time VS. RG, TC=25°C, L=200uH,VCE=400V,VGE=15V,IC=25A

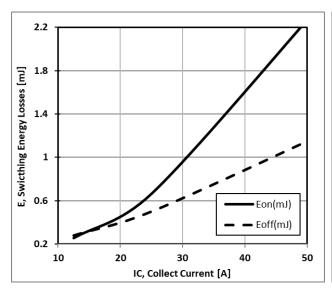


Figure 11: Typical Energy Loss VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=400V,VGE=15V,RG=15 $^{\circ}$

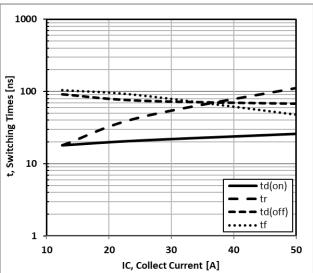


Figure 12: Typical Switching Time VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=400V,VGE=15V,RG=15 $^{\circ}$



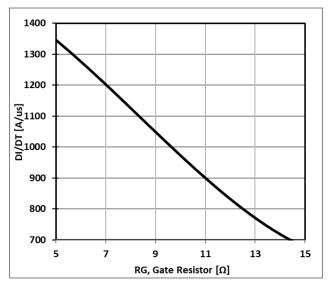


Figure 13: Typical Diode DI/DT VS. RG,TC= 25° C VCC=400V, VGE=15V, IF=25A

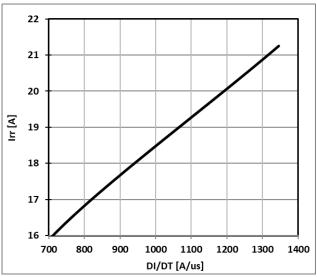


Figure 14: Typical Diode IRR VS. DI/DT,TC=25°C VCC=400V, VGE=15V, IF=25A

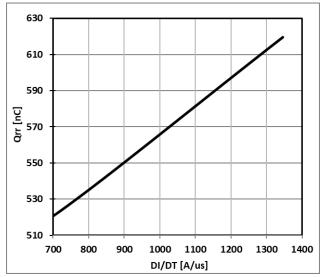


Figure 15: Typical Diode Qrr VS. DI/DT,TC=25℃ VCC=400V, VGE=15V, IF=25A

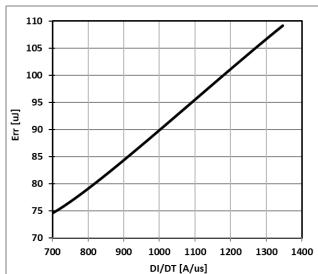


Figure 16: Typical Diode Err VS. DI/DT,TC=25 $^{\circ}$ C VCC=400V, VGE=15V, IF=25A



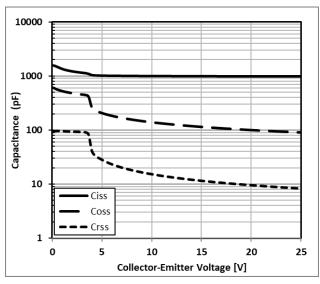


Figure 17: Typical Capacitance VS. VCE, VGE=0V,f=1MHz

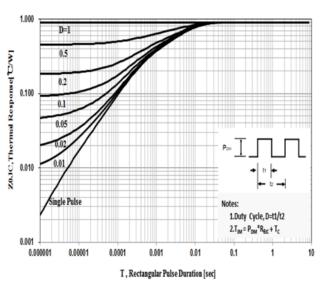
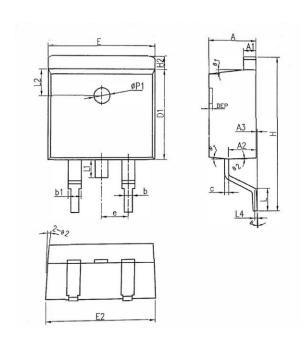


Figure 18: Normalized transient thermal impedance junction-to-case





TO-263 PACKAGE OUTLINE



SYMBOL	MM			NCH.			
	MIN	NOM	MAX	MIN	NOM	MAX	
Α	4.40	4.57	4.70	0.173	0.180	0.185	
A1	1.22	1.27	1.32	0.048	0.050	0.052	
A2	2.59	2.69	2.79	0.102	0.106	0.110	
A3	0.00	0.10	0.20	0.000	0.004	0.008	
b	0.77	0.813	0.90	0.030	0.032	0.035	
b1	1.20	1.270	1.36	0.047	0.050	0.054	
С	0.34	0.381	0.47	0.013	0.015 0.019		
D1	8.60	8.70	8.80	0.339	0.343	0.346	
E	10.00	10.16	10.26	0.394	0.400	0.404	
E2	10.00	10.10	10.20	0.394	0.398	0.402	
е	2.54 BSC			0.100 BSC			
Н	14.70	15.10	15.50	0.579	0.594	0.610	
H2	1.17	1.27	1.40	0.046	0.050 0.05		
L	2.00	2.30	2.60	0.079	0.091	0.102	
L1	1.45	1.55	1.70	0.057	0.061	0.067	
L2	2.50 REF			0.098 REF			
L4	0.25 BSC			0.010 BSC			
θ	0°	5°	8°	0°	5°	8°	
θ1	5°	7°	9°	5°	7°	9°	
θ2	1°	3°	5°	1°	3°	5°	
ФР1	1.40	1.50	1.60	0.055	0.059	0.063	
DEP	0.05	0.10	0.20	0.002	0.004	0.008	



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